S112S01 Series S116S01 Series

SIP Type SSR for Medium Power Control

■ Features

Compact, high radiation resin mold package

2. RMS ON-state current

S112S01 Series: 12Arms at $T_c \le 70^{\circ}C$

(With heat sink)

S116S01 Series: $16 \text{Arms at } T_C \le 60^{\circ} \text{C}$

(With heat sink)

3. Built-in zero-cross circuit

(S112S02/S212S02/S116S02/S216S02)

4. High repetitive peak OFF-state voltage

S112S01/S112S02/S116S01/S116S02

 V_{DRM} : 400V

S212S01 / S212S02 / S216S01 / S216S02

 $V_{DRM}:600V$

5. Isolation voltage between input and output

 $(V_{iso}:4\,000V_{rms})$

6. Recognized by UL, file No. E94758

S112S01/S112S02

S116S01/S116S02

7. Approved by CSA, No. 63705

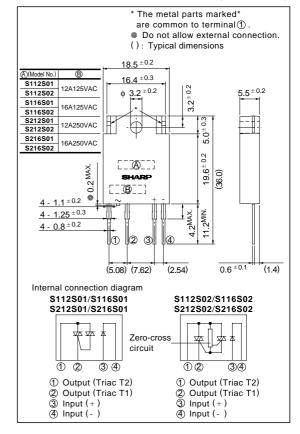
S112S01 / S112S02 S116S01 / S116S02

■ Applications

- 1. Copiers, laser beam printers
- 2. Automatic vending machines
- 3. FA equipment

■ Outline Dimensions

(Unit: mm)



■ Model line-ups

	For 100V	For 200V
	lines	lines
For phase control	S112S01	S212S01
No built-in zero-cross circuit	S116S01	S216S01
D. Th. 1	S112S02	S212S02
Built-in zero-cross circuit	S116S02	S216S02

■ Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Parameter			Symbol	Rating	Unit	_	
T4	Forward current		I_F	50	mA	_	
Input	Reverse voltage		V _R	6	V	_	
	RMS ON-state	S112S01 Series	т	*412	A rms		
	current	S116S01 Series	I_{T}	*516	A rms	*	
Output	*1 Peak one cycle S112S01 Series			120	A		
	surge current	S116S01 Series	I surge	160	A		
	Repetitive peak	S112S01 / S112S02 S116S01 / S116S02	3.7	400	V	_	
	OFF-state voltage	S212S01 / S212S02 S216S01 / S216S02	V_{DRM}	600	V	_	
	Non-repetitive peak OFF-state voltage	S112S01 / S112S02 S116S01 / S116S02	* 7	400	V	_	
		S212S01 / S212S02 S216S01 / S216S02	V _{DSM}	600	V	_	
	Critical rate of rise of ON-state current		dI/dt	50	A/μ s	_	
	Operating frequency	у	f	45 to 65	Hz	_	
	*2 Isolation voltage		Viso	4 000	V rms	_	
	Operating temperature		Topr	- 25 to + 100	°C	_	
Storage temperature		T _{stg}	- 30 to + 125	°C	_		
	*3Soldering temperature		Tsol	260	°C	_	

^{*1} AC 60Hz sine wave, T_j = 25°C

heat sink, please use the in-

■ Electrical Characteristics

 $(Ta = 25^{\circ}C)$

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		V_F	$I_F = 20mA$	-	1.2	1.4	V
	Reverse current		I_R	$V_R = 3V$	-	-	10-4	A
Output	Repetitive peak OI	FF-state current	I_{DRM}	$V_D = V_{DRM}$	-	-	10- 4	A
	ON state voltage	S112S01 Series	V _T	Resistance load $I_F = 20mA$, $I_T = 12Arms$	-	-	1.5	V _{rms}
	ON-state voltage	S116S01 Series		Resistance load $I_F = 20 \text{mA}, I_T = 16 \text{Arms}$	-	-	1.5	$V_{\rm rms}$
	Holding current		I_{H}	-	-	-	50	mA
	Critical rate of rise	of OFF-state voltage	dV/dt	$V_D = 2/3 \bullet V_{DRM}$	30	-	-	V/µ s
	Critical rate of rise OFF-state voltage	of commutating	(dV/dt) _C	$T_j = 125^{\circ}C, V_D = 400V, *6$	5	-	-	V/μ s
	Zero-cross voltage	S112S02 / S212S02 S116S02 / S216S02	V _{ox}	$I_F=8mA$	-	-	35	V
	Minimum trigger	S112S01 / S212S01 S116S01 / S216S01	I _{FT}	$V_D = 12V$, $R_L = 30 \Omega$	-	-	8	mA
Transfer charac- teristics	current	S112S02 / S212S02 S116S02 / S216S02		$V_D = 6V$, $R_L = 30 \Omega$	-	-	8	mA
	Isolation resistance		R _{ISO}	DC500V, RH = $40 \text{ to } 60 \%$	1010	-	-	Ω
	Turn-on time S112S01 / S212S01 S116S01 / S216S01 S112S02 / S212S02 S116S02 / S216S02	t _{on}	AC 50Hz	-	-	1	ms	
				-	-	10	ms	
	Turn-off time		$t_{ m off}$	AC 50Hz	-	-	10	ms
Thermal resistance S112S01 series (Between junction and case) S116S01 series		R th(j - c)	-	-	3.8	-	°C/W	
			-	-	3.3	-	°C/W	
Thermal re	Thermal resistance (Between junction and ambience)		$R_{th(j-a)}$	-	-	40	-	°C/W

*6 S112S01 Series: $dI_T/dt = -6A/ms$ S116S01 Series: $dI_T/dt = -8A/ms$

^{*2} AC 60Hz for 1 minute, 40 to 60 % RH. Apply voltages between input and output by the dielectric withstand voltage tester with zero-cross circuit. (Input and output shall be shorted respectively). (Note) When the isolation voltage is necessary at using external

sulation sheet. *3 For 10 seconds *4 T_C<=70°C

 $^{*5} T_{C} <= 60^{\circ}C$

Fig. 1 RMS ON-state Current vs. Ambient Temperature (S112S01Series)

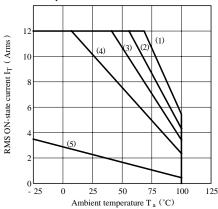
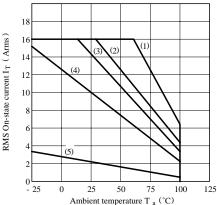


Fig. 2 RMS ON-state Current vs. Ambient Temperature (S116S01Series)



- (1) With infinite heat sink
- (2) With heat sink (280 x 280 x 2 mm Al plate)
- (3) With heat sink (200 x 200 x 2 mm Al plate)
- (4) With heat sink (100 x 100 x 2 mm Al plate)
- (5) Without heat sink

- (1) With infinite heat sink
- (2) With heat sink (280 x 280 x 2 mm Al plate)
- (3) With heat sink (200 x 200 x 2 mm Al plate)
- (4) With heat sink (100 x 100 x 2 mm Al plate)
- (5) Without heat sink
- (Note) With the Al heat sink set up vertically, tighten the device at the center of the Al heat sink with a torque of 0.4N m and apply thermal conductive silicone grease on the heat sink mounting plate. Forcible cooling shall not be carried out.

Fig. 3 RMS ON-state Current vs. Case Temperature

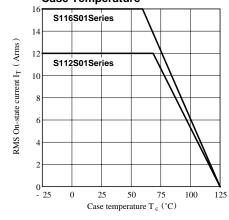


Fig. 4 Forward Current vs.

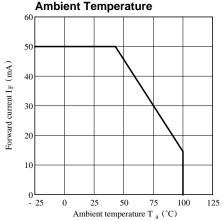


Fig. 5 Forward Current vs. Forward Voltage

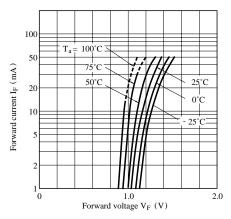


Fig. 7 Maximum ON-state Power Dissipation vs. RMS ON-state Current

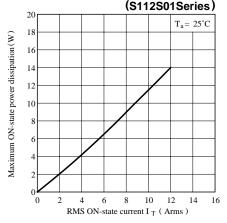


Fig. 9 Minimum Trigger Current vs.
Ambient Temperature

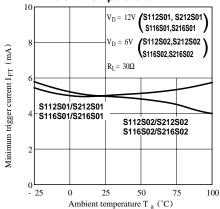


Fig. 6 Surge Current vs. Power-on Cycle

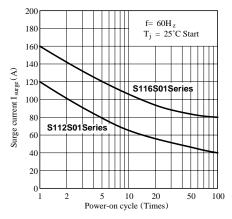


Fig. 8 Maximum ON-state Power
Dissipation vs. RMS ON-state Current
(S116S01Series)

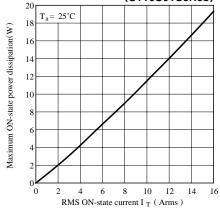


Fig.10 Repetitive Peak OFF-state Current vs.
Ambient Temperature

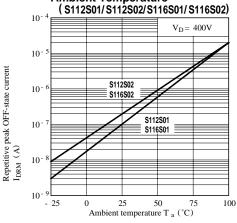
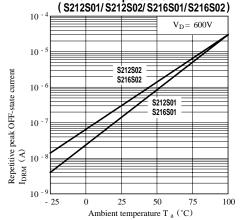




Fig.11 Repetitive Peak OFF-state Current vs. Ambient Temperature (\$212\$01/\$212\$02/\$216\$01/\$216\$02)



• Please refer to the chapter "Precautions for Use."

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